

# Table of Contents

## Preface, Committees and Sponsors

## Chapter 1: Abrasive Machining

<b>On the Profile and Microstructure Variations of Grinding-Induced Hardening Layer in A Cylindrical Workpiece</b> M. Liu, T. Nguyen, L.C. Zhang, Q. Wu and D.L. Sun	3
<b>Study on Grinding Force Distribution on Cup Type Electroplated Diamond Wheel in Face Grinding of Cemented Carbide</b> T. Fujiwara, S. Tsukamoto, K. Ohashi and T. Onishi	9
<b>Investigations on Belt Grinding of GH4169 Nickel-Based Superalloy</b> G.J. Xiao, Y. Huang, G.L. Chen, Z.W. Liu and X.M. Liu	15
<b>Basic Study on High Efficiency Ultra-Precision Grinding of the Optical Glass Lens</b> R. Sekiguchi, S. Yoshikawa, Y. Kakinuma, K. Tanaka and M. Fukuta	21
<b>Studies on Grinding Conditions Affecting the Quality of Soft Magnetic Powder Cores</b> T. Ueno, T. Tokuoka, T. Nishioka, K. Ohashi and S. Tsukamoto	27
<b>Effect of Coolant Supplied through Grinding Wheel on Residual Stress of Grinding Surface</b> N. Nakatsuka, Y. Hirai, A. Kusakabe, Y. Yao and H. Sasahara	33
<b>Multi-Hole Drilling Method by Abrasive Blasting for CFRP and Composite Materials: Investigation of a Processing Model Based on Abrasive Erosion Phenomenon</b> H. Fukagawa, T. Hirogaki, I. Yamada, A. Kato, K. Shimizu and K. Nishikawa	38
<b>A Controllable Material Removal Strategy Considering Force-Geometry Model in Marine Propeller Five-Axis Belt Grinding</b> Y.Q. Wang, B. Hou, Q. Ma, H.B. Liu and X.J. Sheng	44
<b>Form Accuracy of Internal Grinding of Small and Deep Holes with Coolant Supplied from Inner Side of Grinding Wheel</b> K. Matsubara, J. Tsuchimura, S. Kawazoe and H. Sasahara	50
<b>An Experimental Study on Grinding Fir-Tree Root Forms Using Vitrified CBN Wheels</b> Z.D. Shi, A. Elfizy and H. Attia	55
<b>Deformation and Removal Characteristics of Multilayered Thin Film Structures in Nanoscratching and Diamond Lapping</b> C.W. Kang and H. Huang	61
<b>Influence of Work Speed on Surface Quality with Rapid Rotation Mirror-Like Surface Grinding</b> K. Yamaguchi, R. Yamazaki, C.H. Yu, M. Ota, K. Egashira, Y. Akita and S. Suzuki	66
<b>Estimation of Grinding Cycle Time Taking into Account Specific Grinding Force</b> T. Yamada, H.S. Lee and K. Miura	72
<b>Study on the Shape Error in the Cylindrical Traverse Grinding of a Workpiece with High Aspect Ratio</b> T. Onishi, T. Kodani, K. Ohashi, M. Sakakura and S. Tsukamoto	78
<b>Research on Material Removal Mechanism of Single Grit Cutting Based on FEM Simulation</b> L. Yan, F. Jiang and C.F. Fang	82
<b>A Preliminary Study of Surface Integrity and Wheel Wear in the Grinding of Multilayered Thin Film Structures</b> C.W. Kang, B.J. Hao and H. Huang	88
<b>Experiment Research on ZrO<sub>2</sub> Engineering Ceramics with Abrasive Belt Grinding</b> D. Zhang, Y. Huang, X. Yin, L.Q. Zhou, Y.H. Yang and L. Yong	92
<b>Research on Grinding of Silicon Particles Reinforced Aluminum Matrix Composites with High Volume Fraction</b> F.H. Zhang, K. Wang, P.Q. Fu and M.N. Wu	98
<b>Investigation of Grinding Characteristics of Cemented Carbides YL10.2 and YF06</b> T. Xu, J.W. Yu, Z.J. Zhang, J.G. Tu, X.Z. Liu, Y. Wu and L.H. He	104

<b>Optimization of Grinding Conditions in Non-Axisymmetric Aspherical Grinding</b> N. Yoshihara, T. Nakagawa, N. Nishikawa and M. Mizuno	109
<b>Study on the Grinding Machinability of 9Mn2V under Different Heat Treatment Processes</b> G.Q. Guo, Y.J. Mu, C.Q. Yang, Z.Q. Li, Y. Tian and M. Chen	114
<b>Study on Force Characteristics of Ultrasonic Vibration-Assisted Sawing Ceramics with Diamond Blade</b> X. Xiang, J.Y. Shen, Z.W. Hu and X.P. Xu	120

## Chapter 2: Surface Quality

<b>Investigation of Glass Polishing Motion Based on Micro-Oscillating Pressing Force with a Compact Robot and Fine Diamond Stone</b> W. Wu, Y.D. Liu, T. Hirogaki and E. Aoyama	129
<b>Development of Non-Destructive Inspection System for Grinding Burn-in-Process Detection of Grinding Burn</b> R. Ito, N. Mukaide, T. Azuma, S. Soma, S. Murakami and T. Kuriyagawa	135
<b>Feature Extraction Based 3D Model Registration for Surface Finish Quality Evaluation</b> N. Sharma, J. Zhu, T. Tanaka and Y. Saito	141
<b>Dry Sliding Wear Behaviour of Full Pearlite Obtained by Cladding Low Carbon Steel to Hypoeutectoid Steel</b> X.J. Gao, Z.Y. Jiang, D.B. Wei, B.Y. Kosasih, S.H. Jiao and D.F. Chen	147
<b>Material Properties of a New PCD Made of Boron Doped Diamond Particles</b> W. Chen, M. Iwai, S. Ninomiya and K. Suzuki	154
<b>Dynamic Friction Polishing of Diamond Utilizing High Reactive Metallic Tools</b> W. Chen, M. Iwai and K. Suzuki	160
<b>Evaluation and ANN-Based Prediction on Functional Parameters of Surface Roughness in Precision Grinding of Cast Iron</b> B. Zhao, S. Zhang and J.F. Li	166

## Chapter 3: Brittle Material Machining

<b>An Experimental Study on Single Point Diamond Turning of an Unpolished Silicon Wafer via Micro-Laser Assisted Machining</b> H. Mohammadi, H.B. Poyraz, D. Ravindra and J.A. Patten	175
<b>Effect of Cutting Fluid on Diamond Tool Life under Micro V-Groove Turning of Cobalt-Free Tungsten Carbide</b> A. Yui, T. Kitajima, P. Krajnik, K. Harano, H. Sumiya and H. Ono	181
<b>A Three-Dimensional Fractal Analysis Method for Ground Monocrystal Sapphire Surface</b> Q.Y. Wang, Z.Q. Liang, X.B. Wang, W.X. Zhao, Y.B. Wu, L. Jiao and L.J. Xie	187
<b>Microgrooving of Germanium Wafers Using Laser and Hybrid Laser-Waterjet Technologies</b> H. Zhu, J. Wang, W.Y. Li and H.Z. Li	193
<b>An SPH Simulation on Vibration Assisted Abrasive Erosion of Hard Brittle Material in Abrasive Waterjet Machining</b> Z. Lv, C.Z. Huang, H.T. Zhu, J. Wang, P. Yao and Z.W. Liu	199
<b>Machining Characteristics in Cylindrical Blasting of Micro Grooves and Performance of Herring-Bone Bearing</b> T. Fukushima, K. Ohashi, M. Fujihara, T. Onishi and S. Tsukamoto	205
<b>Study on the Model of Surface Crack Depth in Ceramics Grinding</b> J.K. Su, B. Lin and L. Wang	212
<b>Radial Directional Vibration-Assisted Ductile-Mode Grinding of Engineering Ceramic</b> K. Imai	218
<b>Blind Hole Machining of Quartz Fiber Reinforced Ceramic Matrix Composites by Helical Milling with Electroplated Diamond Tool</b> H. Gao, T. Zhao, Y.J. Bao, C. Sun and S.X. Lu	222
<b>A Study on Erosion of Alumina Wafer in Abrasive Water Jet Machining</b> Y. Wang, H.T. Zhu, C.Z. Huang, J. Wang, P. Yao and Z.W. Zhang	228

## Chapter 4: Grinding Wheel

<b>Optimizing the Dry Grinding Process on the Basis of Bond Materials</b> H. Kitizig, N. Jandaghi, B. Azarhoushang and A. Vesali	237
<b>High Efficiency Abrasive Waterjet Dressing of Diamond Grinding Wheel</b> P. Yao, W. Wang, C.Z. Huang, J. Wang, H.T. Zhu and Z.Y. Zhang	243
<b>An Explorative Study of Fabrication of Al-Based Matrix Diamond Grinding Wheels by Vacuum Evaporative Pattern Casting</b> Q.L. Dai, F.Y. You and C.B. Luo	249
<b>Wafer Grinding of Using Fixed Abrasive Diamond Wheel - Evaluation of Cutting Edge Distribution in Diamond Wheels</b> Y. Ebina, L.B. Zhou, J. Shimizu, T. Onuki and H. Ojima	255
<b>Wear of Diamond Wheel in Groove Grinding of Cemented Carbide - Influences of Speed Ratio and Nitrogen Gas Dissolved Coolant</b> O. Horiuchi, T. Samura, T. Uno, T. Itazu, N. Ito, T. Shibata and M. Masuda	261
<b>Evaluation of Grinding Performance by Mechanical Properties of Super Abrasive Wheel - Relationship between Modulus of Rupture and Critical Grain Holding Power (2<sup>nd</sup> Report)</b> T. Sawa, N. Nishikawa and Y. Ikuse	267
<b>Investigation on Properties of Magnesia Grinding Wheels Used in Silicon Wafer Grinding</b> B.J. Hao, Z.G. Dong, S. Gao, R.K. Kang and D.M. Guo	273

## Chapter 5: High Efficiency Machining

<b>Research on 3D Model Processing Technologies in the Application of Freeform Surface Machining</b> J. Zhu, T. Tanaka and Y. Saito	281
<b>Stress Influence on Corrosion Resistance of Aluminum Alloy Surface</b> Y. Wan, Z. Wang, Z.Q. Liu, Z.L. Jiang and D. Zhang	287
<b>Distribution of the Convection Heat Transfer Coefficients of Grinding Fluids along the Contact Zone in High Speed Grinding</b> T. Jin	292
<b>Performance of Strong Alkali Ion Water in Cutting and Grinding Applications</b> M. Iwai, H. Hashimoto, M. Yamada, H. Yamada and K. Suzuki	298
<b>Study of Grinding Wheel for Polishing Diamond by Dynamic Friction Polishing</b> S.J. Shi, J.Z. Lin, Z.J. Jin, X.G. Guo, P. Zhou and R.K. Kang	304
<b>Influence of Tool Shape and Coating Type on Machined Surface Quality in Face Milling of CFRP</b> T. Furuki, T. Hirogaki, E. Aoyama, H. Kodama and K. Ogawa	310

## Chapter 6: Cutting Technology

<b>Machining of Sintered Tungsten Carbide for Die and Mold</b> T. Moriwaki, S. Tsurimoto, K. Osakada and M. Nagata	319
<b>Laboratory Comparison of SMART*<sup>®</sup>CUT Picks With WC Picks</b> W. Shao, X.S. Li, Y. Sun and H. Huang	323
<b>Essential Research in Machining Difficult-to-Machine Materials for Advancing MQL Cutting Technology with a Newly Developed Coated Tool</b> S. Shimada and M. Kohzaki	329
<b>Experimental Verification of End-Milling Condition Decision Support System Using Data-Mining for Difficult-to-Cut Materials</b> H. Kodama, T. Hirogaki, E. Aoyama, K. Ogawa and K. Okuda	334
<b>High Speed Machining Method of Large-Size Precision Freeform Mirror</b> O. Kirino, H. Nakagawa, S. Kirino and H. Kataza	340
<b>A Study on Straightness of Deep Hole in Small-Diameter Drilling of Stainless Steel</b> K. Okuda, T. Yamaguchi, T. Yamamoto, T. Takeda and H. Shizuka	344

<b>Development of Axially Splitting Method for the Pipe Materials with the Cutting Tool</b> E. Nakanishi, M. Hyono and S. Maki	350
<b>Small Hole Drilling for Polyphenylene Sulfide (PPS) - Influence of Depth-of-Cut on Burr Formation</b> M. Nomura, K. Suzuki, Y.B. Wu and M. Fujimoto	355
<b>Investigation Performance of AlCrN Based Coated Broaching Tool in Broaching of Gas Turbine Material X12CrMoWVNbN1011</b> Z.Q. Liu, M. Chen, C.D. Wang, Q.L. An, C.X. Ge and G.Q. Guo	361
<b>Study on Surface Finish of Carbon Steel by Ultra-Precision Diamond Cutting</b> Y. Kamoi, K. Okuda, H. Shizuka and M. Nunobiki	367
<b>A Study of Ultrasonically Added High Speed Turning for Stainless Steel - The Effects of Ultrasonic Oscillating Direction and Chip Breaker Shape and Material</b> K. Hara, R. Sasaki, T. Koiwa and H. Isobe	373
<b>Investigation of the Surface-Modification Effect by Oil-Immersion Treatment on Carbide Tool</b> H. Shizuka, K. Sakai and K. Iwakura	377
<b>Face Milling of Carbon Fiber Reinforced Plastic Using Poly Crystalline Diamond Tool</b> J. Kusuyama, A. Yui, T. Kitajima and Y. Itoh	383
<b>Cutting Performance of Binder-Less Nano-Polycrystalline cBN Tool</b> K. Harano, K. Arimoto, Y. Ishida and H. Sumiya	389
<b>An Innovative Cooling Method for Grinding Process Based on Heat Pipe Technology</b> J.J. Chen, Y.C. Fu, Q.S. He, W. Zhang and Y.B. Zhu	393
<b>Simulations of Milling Process of Inconel 718 Alloy Based on Three Dimensional Finite Element Models</b> L.J. He, H.H. Su, J.H. Xu and J.B. Fu	399
<b>Wear Characteristics of Binder-Less Nano-Polycrystalline Diamond and Cubic Boron Nitride</b> H. Sumiya and K. Harano	406
<b>Development of PCD Milling Tool for Carbon-Fiber-Reinforced Plastics</b> T. Kitajima, J. Kusuyama, A. Yui, K. Fujii and Y. Itoh	411

## **Chapter 7: Tribology in Manufacturing**

<b>Friction Characteristics with Pin-on-Disc Friction Test on Microstructured Surface Using Whirling Electrical Discharge Texturing</b> V. Lertphokanont, T. Sato, M. Oi, M. Ota, K. Yamaguchi and K. Egashira	417
<b>Tribo-Electrochemical Performance of Polycrystalline Silicon during ECMP Simulating Process</b> W.J. Zhai and J.H. Wang	423
<b>Long-Duration Frictional and Wear Performance of the Diamond/DLC Bilayered Film under Water-Lubricating Condition</b> S.L. Chen, B. Shen and F.H. Sun	429
<b>Tribological Analysis of Oxide Scales during Cooling Process of Rolled Microalloyed Steel</b> Z.Y. Jiang, X.L. Yu, J.W. Zhao, C.L. Zhou, Q.X. Huang, G.Z. Luo and K.Z. Linghu	435
<b>Study on Identification of Contact Stiffness Considering Surface Roughness</b> K. Nakamura and H. Sakamoto	441
<b>Study on the Tribological Property of Bionic Lead Rail Using ABAQUS</b> L.J. Ma, L.C. Gu, Y.Z. Luo, F.W. Wang and X.H. Chen	447
<b>A Wear Simulation of the Fixed Soft Abrasive Film Based on Discrete Element Method</b> Z.Z. Zhou, K.P. Feng and J.L. Yuan	452
<b>Investigation of Grinding Fluid Supply Parameters on Workpiece Surface Integrity</b> S.C. Xiu, X.M. Zhang, A. Jiang, X.L. Shi, S.J. Li and X.P. Li	458

## **Chapter 8: Micro/Nano Machining**

<b>Precision Machining of Parabolic Mirror Made of Low Thermal Expansion Ceramic</b> M. Okada, A. Takagi, H. Suzuki and J. Sugawara	467
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<b>Synergistic and Strengthening Mechanism of Twin Boundaries under Nanoindentations for Cadmium Telluride Semiconductors</b> H.X. Zhou, N.D. Duan and B. Wang	473
<b>Removal of Ion Irradiation-Induced Affected Layers from Diamond Cutting Tools to Improve Machining Performance</b> N. Kawasegi, K. Ozaki, N. Morita, K. Nishimura and H. Sasaoka	479
<b>Fabrication of Shapes with Overhang Using Micro-Boring Tools</b> K. Egashira, K. Harada, K. Yamaguchi and M. Ota	485
<b>Ultraprecision Micro Grooving on Brass for Surface Wettability Control</b> K. Asakura and J.W. Yan	489
<b>Influence of Processing Parameters on Surface Roughness in Micro Mill-Grinding Aluminium Alloy 6061</b> Y.D. Gong, C. Wang, J. Cheng, X.L. Wen and G.Q. Yin	495
<b>Experiment Research on Surface Roughness in Micro-Grinding Metal Material</b> Y.D. Gong, X.L. Wen, Z.X. Zhu, J. Cheng, G.Q. Yin and C. Wang	500

## **Chapter 9: Finishing/Lapping/Polishing**

<b>Preliminary Study on Highly Efficient Polishing of 4H-SiC by Utilization of Anodic Oxidation</b> K. Yamamura, K. Hosoya, Y. Imanishi, H. Deng and K. Endo	509
<b>Development of an Advanced Machine Control System in Superfinishing the Automatic Determination of the Suitable Machining Time</b> T. Onishi, K. Ohashi, K. Higashi, T. Iguchi, S. Yamashita, H. Isa and S. Tsukamoto	515
<b>Study on Fixed-Abrasive Lapping SiC Crystal Substrate Based on Diamond Particle</b> J.X. Su, X.M. Zhang, S.F. Fu, S.Z. Fan and Z.L. Liu	520
<b>Precision Shaping Experiment of Ceramic Ball Blank with Oscillating-Plate Lapping Method</b> B.H. Lyu, C.C. Dong, F.F. Zhou, Q.F. Deng, J.L. Yuan and P. Zhao	526
<b>Advanced Abrasive Processes for Manufacturing Prototype Mirror Segments for the World's Largest Telescope</b> D. Walker, G. Davies, T. Fox-Leonard, C. Gray, J. Mitchell, P. Rees, H.Y. Wu, A. Volkov and G.Y. Yu	532
<b>Effect of Cyclic Heating on the Hardened Layer Properties Generated by Plunge Cylindrical Grinding</b> T. Nguyen, M. Liu, L.C. Zhang, Q. Wu and D.L. Sun	539
<b>Grinding Performance of Diamond Grinding Tools for Sapphire Crystal</b> Y. Zhang, S. Gao, R.K. Kang, X.G. Guo and Z.F. Lin	544
<b>Characterization of Cutting Ability of Electroplated Diamond Wire Used for Multi-Wire Saw</b> H.J. Kim, D.Y. Kim, S.J. Lee, H.D. Jeong and H.J. Choi	549
<b>Micro-Cracks Removal on Edge Surface of Thin Glass Sheet Using Magnetorheological Finishing</b> T. Sato, C.W. Kum and S.T. Ng	553
<b>Study on the Flow Pressure of Mass in Centrifugal Disc Finishing</b> Y. Matsumoto, T. Yamaguchi, K. Kitajima, A. Yamamoto and S. Takahashi	559
<b>Research on Performance of Fixed Abrasive Tools of Polishing 6H-SiC Wafers</b> J. Lu, G.Q. Hu, G.Q. Huang, C.F. Fang and X.P. Xu	565

## **Chapter 10: System Development**

<b>Conditioning of Vitrified Bond CBN Grinding Wheels Using a Picosecond Laser</b> A. Zahedi, T. Tawakoli, J. Akbari and B. Azarhoushang	573
<b>Design of Double-Sided Polishing Machine for Functional Crystal Substrate</b> J.S. Yang, X.L. Zhu, Z.G. Dong, R.K. Kang, D.M. Guo and B. Zhang	580
<b>Development of Non-Contact Classifying Systems by Use of Acoustic Levitation</b> T. Inada, L.B. Zhou, J. Shimizu, H. Ojima and T. Ito	586

<b>Computer-Aided Simulation of Dressing Using Diamond Rotary Dresser and Visualization of Dressing Process</b>	
A. Kubo, A.M.M. Sharif Ullah and J. Tamaki	592
<b>Simulation of Chip Formation Behavior during Single Diamond Grains Grinding by CEL Method</b>	
C.W. Dai, J.H. Xu, W.F. Ding, J.B. Dai and Y.C. Fu	598
<b>Development of Rotary Work Table with Constant-Flow Hydrostatic Water Bearing for Large Scale Silicon-Wafer Grinding Machine</b>	
G. Okahata, A. Yui, T. Kitajima, S. Okuyama, H. Saito and A.H. Slocum	604
<b>Development of a Fine Grating on ZnS for a Wideband Spectral Disperser in Characterizing Exoplanets Using Space-Borne Telescopes</b>	
K. Enya, T. Sukegawa, S. Sugiyama, F. Iijima, N. Fujishiro, Y. Ikeda, T. Yoshikawa and M. Takami	610

## Chapter 11: Monitoring & Analysis

<b>Sensorless Cutting Force Estimation in Ball-Screw-Driven System Using Triple-Inertia Model</b>	
Y. Yamada, Y. Kakinuma, T. Ito, J. Fujita, M. Sawazaki and M. Sagara	619
<b>Monitoring of End-Mill Temperature with Infrared Thermography and Wireless Tool Holder System</b>	
M. Shindou, R. Matsuda, T. Furuki, T. Hirogaki and E. Aoyama	624
<b>Experimental Study on the Cutting Performance of <i>In Situ</i> Fabricated TiB<sub>2</sub> Toughened TiN-Based Composite Ceramic Tool in Turning Stainless Steel</b>	
H.L. Liu, Q. Shi, C.Z. Huang, L.M. Wang, B. Zou and Z.H. Yang	630
<b>Entire Hardening of Small Thin Plate with a Small Power Semiconductor Laser Considering Plate Deformation</b>	
R. Oda, T. Hirogaki, E. Aoyama and K. Ogawa	636
<b>Investigation of Step Micro-Drilling Motion Based on Modeling of High Speed Spindle Driving Axis on Machine Tools Equipped with Vibration-Proof Mechanism</b>	
T. Yamashita, T. Hirogaki, E. Aoyama, R. Shibata and K. Ogawa	642
<b>Study on a Novel Brazed Diamond Wire with CuSnTi Brazing Filler</b>	
X.H. Zhu, H. Huang, H. Guo, Y.Q. Yu and X.P. Xu	648
<b>A 5-Axis Coordinated CNC Grinding Method for the Flank of a Non-Coaxial Helical Micro-Drill with the Cylinder Grinding Wheel</b>	
Z.Q. Liang, H.C. Jian, X.B. Wang, W.X. Zhao, S.Y. Zhang, Y. Otani and S.Y. Xue	654

## Chapter 12: Metrology & Evaluation

<b>Manufacturing Process Evolution Method of Neutron Ellipsoidal Mirror Simulation Using Measured Point-Set</b>	
S. MORITA, S. Takeda, M. Furusaka, J. Guo and Y. Yamagata	663
<b>A Study on Fast Geometric Form Measurement of High Precision Balls</b>	
H.Z. Lu, Z.W. Wang, Q.F. Deng, B.H. Lv, F.F. Zhou and J.L. Yuan	669
<b>Development and Practicality of a Scanning Point Autofocus Instrument for High Speed Areal Surface Texture Measurement</b>	
K. Miura, A. Nose, H. Suzuki and M. Okada	675
<b>Influence of Surface Integrity in Silicon Wafer Thickness Measurements by Reflection Spectroscopy</b>	
T. Onuki, R. Ono, H. Ojima, J. Shimizu and L.B. Zhou	681
<b>The Topographic Characterisation of Grinding Wheels – A Proposed Measurement Strategy</b>	
D.L. Butler	686
<b>Estimation of Machining Error in Ball-End Milling of Hemispherical Surface Based on Measured Cutting Force</b>	
K. Shimana, E. Kondo, S. Yamashita, Y. Kawano and N. Kawagoishi	692
<b>Monitoring of Wear Land Width of Diamond Tool Cutting Edge with Large Nose Radius in Ultra-Precision Cutting Using Static Cutting Forces</b>	
E. Kondo, R. Iwamoto and Y. Kobaru	696

## Chapter 13: Chemo-Mechanical Polishing

<b>Future Prospects for CMP Equipment - Design Considerations According to Substrate Size and Shape</b> H.D. Jeong, H.J. Kim and H.J. Choi	705
<b>Measuring Surface Topography of a Diamond Wire Using an Image Processing Method</b> A. Sakaguchi, T. Kawashita and S. Matsuo	709
<b>Effect of Surface Profile on the Material Removal Rate Distribution in CMP Process</b> P. Zhou, J.Q. Cai, Z.W. Li, R.K. Kang and Z.J. Jin	715
<b>Chemical Mechanical Polishing of Soft-Brittle Cadmium Zinc Telluride Wafers Using a Developed Environment-Friendly Solution</b> Z.Y. Zhang, B. Wang and Y.X. Song	720
<b>Effectiveness Evaluation of Novel Pad Dressing Method by Flexible Fiber Dresser - Tool Life Evaluation of Flexible Fiber Dresser</b> M. Uneda, N. Takahashi, Y. Arai and T. Fujita	726

## Chapter 14: Non-Traditional Machining

<b>Numerical Investigations on the Grinding Forces in Ultrasonic Assisted Grinding of SiC Ceramics by Using SPH Method</b> Z.Q. Liang, Z.Y. Mi, X.B. Wang, T.F. Zhou, Y.B. Wu and W.X. Zhao	735
<b>The Influence of Amplitude on Grinding Force and Surface Roughness in Ultrasonic Assisted Grinding of K9 Glass</b> F.F. Zheng, F.J. Ma, Y.D. Wang, Z.G. Dong and R.K. Kang	741
<b>High-Speed Capturing of Stress Distribution of Workpiece under Ultrasonically Assisted Cutting Condition</b> H. Isobe and K. Hara	747
<b>Effect of Frequency and Amplitude on the Performance of Elliptic Vibration-Assisted Cutting of Fibre-Reinforced Polymer Composites</b> W.X. Xu and L.C. Zhang	753
<b>Smoothed Particle Hydrodynamics Simulations for Ultrasonic Machining of Different Workpiece Materials</b> J.S. Wang, K. Shimada, M. Mizutani and T. Kuriyagawa	758
<b>Modeling and Simulation of Surface Topography Evolution in Electrical Discharge Machining (EDM)</b> T.F. Zhou, L.Z. Ma, Z.Q. Liang and X.B. Wang	764
<b>Wire-EDM Properties of EC-PCD Made up of Boron Doped Diamond Particles</b> W. Chen, S. Ninomiya, S. Nochi, M. Iwai and K. Suzuki	770
<b>Performance of EC-PCD Made of Boron Doped Diamond as an Electrode for EDM of Cemented Carbide</b> W. Chen, M. Iwai, S. Ninomiya and K. Suzuki	776
<b>EDM Machinabilities of EC-PCD Using Ultrasonic Assisted EDM and Bipolar Pulse Current EDM</b> W. Chen, M. Iwai and K. Suzuki	782
<b>Curved Surfaces Forming of Sheet Material by Laser Irradiation</b> K. Kishida, H. Aoyama, N. Mastushita and A. Ushimaru	788
<b>Production of Fe-Al Alloy Coat on Steel Block by Scanning Laser Beam</b> M. Nunobiki, Y. Harada and K. Okuda	794
<b>Ultrasonic Vibration Assisted Grinding of Sintered Dental Zirconia Ceramics: An Experimental Study on Surface Roughness</b> S. Dong, K. Zheng and X.Z. Xiao	800
<b>External Magnetic Field Control during EDM of a Permanent Magnet</b> H. Takezawa, N. Yokote and N. Mohri	806
<b>Development of Ultrasonic Lapping Equipment for Small Holes Finishing</b> J. Liang, R.K. Kang, F.J. Ma, J.T. Liu and Y.B. Yu	812
<b>Experimental Investigation of Copper-Tungsten Electrode Wear in EDM</b> J.W. Yu, L.H. He, X.M. Sheng, W. Duan, S.H. Yin and Z.T. Shang	818

**Proposal of Micro Removal Process with Pulsed Laser Irradiation Based on Form  
Generation Theorem**

H. Sakamoto and K. Morioka